



PRODUCT DATA SHEET



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Datasheet

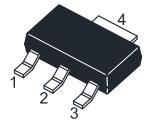
es Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.

PNP Silicon Epitaxial Planar Power Transistor

Features

• Halogen and Antimony Free(HAF), RoHS compliant



1.Base 2.Collector 3.Emitter 4. Collector SOT-223 Plastic Package

Absolute Maximum Ratings (T_a = 25°C)

Parameter	Symbol	Value	Unit	
Collector Base Voltage	-V _{CBO}	100	V	
Collector Emitter Voltage	-V _{CEO}	80	V	
Emitter Base Voltage	-V _{EBO}	5	V	
Collector Current	-I _C	1	А	
Peak Collector Current	-I _{CM}	1.5	Α	
Peak Base Current	-I _{BM}	0.2	Α	
Total Power Dissipation	P _{tot}	1.3	W	
Junction Temperature	T _j	150	°C	
Storage Temperature Range	T _{stg}	- 65 to + 150	°C	

Thermal Characteristics

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient 1)	$R_{ heta JA}$	96	°C/W	

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.



Characteristics at T_a = 25°C

Onaracteristics at 1a - 25 O										
Parameter	Symbol	Min.	Тур.	Max.	Unit					
DC Current Gain at $-V_{CE} = 2 \text{ V}$, $-I_{C} = 5 \text{ mA}$ at $-V_{CE} = 2 \text{ V}$, $-I_{C} = 500 \text{ mA}$ at $-V_{CE} = 2 \text{ V}$, $-I_{C} = 150 \text{ mA}$	-10 -16	h _{FE} h _{FE} h _{FE}	40 25 63 100		- - 160 250	- - -				
Collector Base Cutoff Current at -V _{CB} = 30 V		-I _{CBO}	-	-	100	nA				
Emitter Base Cutoff Current at -V _{EB} = 5 V		-I _{EBO}	-	-	100	nA				
Collector Base Breakdown Voltage at $-I_C = 100 \mu A$		-V _{(BR)CBO}	100	-	-	V				
Collector Emitter Breakdown Voltage at -I _C = 10 mA		-V _{(BR)CEO}	80	-	-	٧				
Emitter Base Breakdown Voltage at -I _E = 10 μA		-V _{(BR)EBO}	5	-	-	V				
Collector Emitter Saturation Voltage at $-I_C = 500$ mA, $-I_B = 50$ mA		-V _{CE(sat)}	-	1	0.5	V				
Base Emitter Voltage at -V _{CE} = 2 V, -I _C = 500 mA		-V _{BE(on)}	-	-	1	V				
Transition Frequency at $-V_{CE} = 10 \text{ V}$, $-I_{C} = 50 \text{ mA}$, $f = 100 \text{ MHz}$		f _⊤	-	125	-	MHz				



Electrical Characteristics Curves

Fig. 1 Output Characteristics Curve

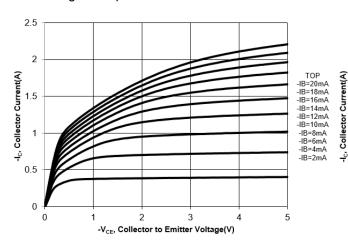


Fig. 2 Output Characteristics Curve

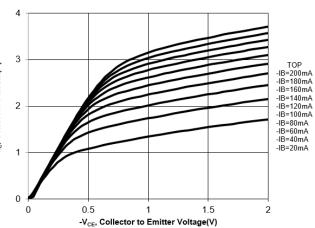


Fig. 3 Collector Current vs. Base to Emitter Voltage

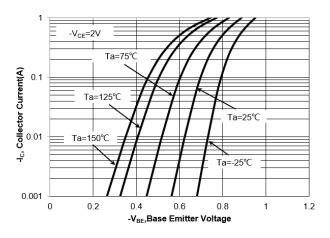
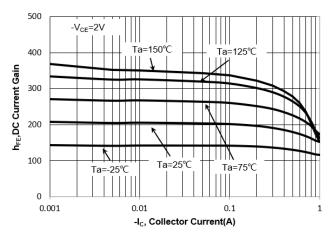


Fig. 4 h_{FE},DC Current Gain vs. Collector Current





Electrical Characteristics Curves

Fig. 5 $V_{\text{BE(SAT)}}$ vs. Collector Current

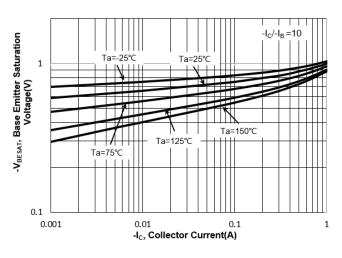


Fig. 6 V_{CE(SAT)} vs. Collector Current

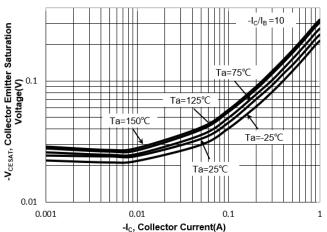


Fig. 7 Junction Capacitance

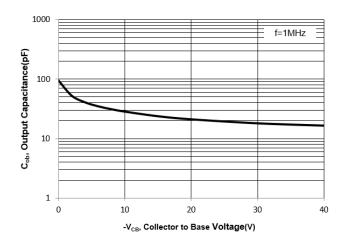
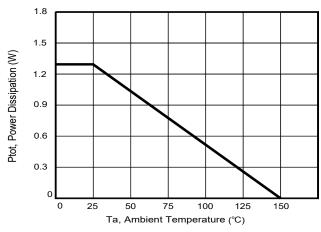


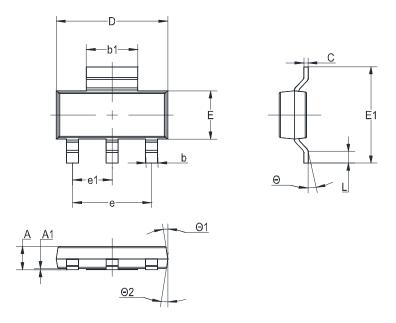
Fig. 8 Power Derating Curve





Package Outline (Dimensions in mm)

SOT-223



Unit	Α	A1	b	b1	С	D	Е	E1	е	e1	L	Θ	Θ1	Θ2
	1.8	0.1	0.8	3.1	0.32	6.7	3.7	7.3	4.6	2.3	1.1	10°	7°	7°
mm	1.5	MAX	0.6	2.9	0.22	6.3	3.3	6.7	TYP	TYP	0.7	0°	0°	0°



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